AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, listings, of claims in the application:

Listing of Claims:

1. (currently amended) A micro-storage device capable of being conjoined with a personal adornment, comprising:

a substrate <u>comprising</u> having a circuit board <u>part</u> and a <u>connecting head</u> connector extended from the circuit board <u>part</u>, wherein the <u>connecting head</u> connector is arranged with a plurality of contacts for electrically connecting to an external electronic apparatus, <u>wherein the contacts are directly printed on the substrate</u>;

at least one electronic component mounted on a surface of the circuit board part using a Chip On Board (COB) or Surface Mount Technology (SMT) an advance package technique; and

a metal case housing the substrate and the electronic component and having an opening at the <u>connecting head</u> connector for coupling to the external electronic apparatus.

- 2. (currently amended) The micro-storage device as claimed in claim 1, further comprising a small hollow object for <u>holding</u> being inserted with the micro-storage device to thereby conveniently carrying carry the micro-storage device.
- 3. (original) The micro-storage device as claimed in claim 2, wherein the small hollow object is a personal adornment.
- 4. (original) The micro-storage device as claimed in claim 3, wherein the personal adornment is a necklace.

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- 5. (original) The micro-storage device as claimed in claim 3, wherein the personal adornment is a tie clip.
 - 6. (canceled)
- 7. (original) The micro-storage device as claimed in claim 1, wherein the electronic component comprises a non-volatile memory to store data.
- 8. (currently amended) The micro-storage device as claimed in claim 1, further comprising <u>additional</u> electronic components mounted [[on]]in an opposite <u>place</u> than[[of]] the <u>connecting head connector</u> in the substrate to effectively utilize space.